# DATA SHEET

**74LV04**Hex inverter

Product specification
Supersedes data of 1997 Feb 03
IC24 Data Handbook

1998 Apr 20







Hex inverter 74LV04

#### **FEATURES**

• Wide operating voltage: 1.0 to 5.5 V

Optimized for low voltage applications: 1.0 to 3.6 V

Accepts TTL input levels between V<sub>CC</sub> = 2.7 V and V<sub>CC</sub> = 3.6 V

 Typical V<sub>OLP</sub> (output ground bounce) < 0.8 V at V<sub>CC</sub> = 3.3 V,  $T_{amb} = 25^{\circ}C$ 

 Typical V<sub>OHV</sub> (output V<sub>OH</sub> undershoot) > 2 V at V<sub>CC</sub> = 3.3 V,  $T_{amb} = 25^{\circ}C$ 

Output capability: standard

I<sub>CC</sub> category: SSI

#### **DESCRIPTION**

The 74LV04 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC/HCT04.

The 74LV04 provides six inverting buffers.

#### **QUICK REFERENCE DATA**

GND = 0 V;  $T_{amb} = 25^{\circ}C$ ;  $t_{r} = t_{f} \le 2.5 \text{ ns}$ 

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nA to nY	C <sub>L</sub> = 15 pF; V <sub>CC</sub> = 3.3 V	6	ns
C <sub>I</sub>	Input capacitance		3.5	pF
C <sub>PD</sub>	Power dissipation capacitance per gate	See Notes NO TAG and 2	21	pF

## NOTES:

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ )

P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> +  $\sum$  (C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where:  $f_i$  = input frequency in MHz; C<sub>L</sub> = output load capacitance in pF;  $f_o$  = output frequency in MHz; V<sub>CC</sub> = supply voltage in V;  $\sum$  (C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

2. The condition is  $V_1$  is  $V_1 = GND$  to  $V_{CC}$ .

## **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	-40°C to +125°C	74LV04 N	74LV04 N	SOT27-1
14-Pin Plastic SO	-40°C to +125°C	74LV04 D	74LV04 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +125°C	74LV04 DB	74LV04 DB	SOT337-1
14-Pin Plastic TSSOP Type I	–40°C to +125°C	74LV04 PW	74LV04PW DH	SOT402-1

# **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	FUNCTION
1, 3, 5, 9, 11, 13	1A – 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y – 6Y	Data outputs
7	GND	Ground (0 V)
14	V <sub>CC</sub>	Positive supply voltage

# **FUNCTION TABLE**

INPUTS	OUTPUTS
nA	nY
L	Н
Н	L

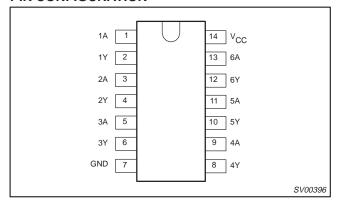
#### NOTES:

H = HIGH voltage level

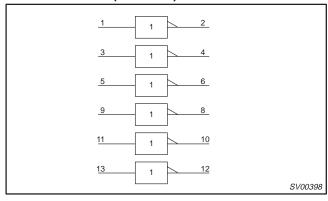
L = LOW voltage level

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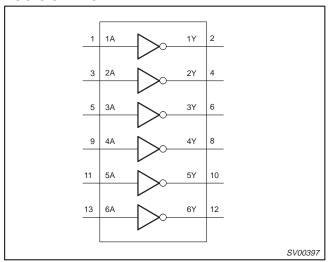
## **PIN CONFIGURATION**



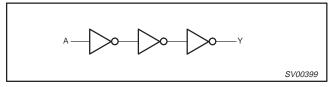
# LOGIC SYMBOL (IEEE/IEC)



## **LOGIC SYMBOL**



# LOGIC DIAGRAM (ONE INVERTER)



# **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	See Note <sup>NO TAG</sup>	1.0	3.3	5.5	V
V <sub>I</sub>	Input voltage		0	-	V <sub>CC</sub>	V
Vo	Output voltage		0	_	V <sub>CC</sub>	V
T <sub>amb</sub>	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V$ $V_{CC} = 2.0V \text{ to } 2.7V$ $V_{CC} = 2.7V \text{ to } 3.6V$ $V_{CC} = 3.6V \text{ to } 5.5V$	- - - -	- - - -	500 200 100 50	ns/V

# NOTE:

1. The LV is guaranteed to function down to  $V_{CC}$  = 1.0V (input levels GND or  $V_{CC}$ ); DC characteristics are guaranteed from  $V_{CC}$  = 1.2V to  $V_{CC}$  = 5.5V.

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# ABSOLUTE MAXIMUM RATINGSNO TAG, NO TAG

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
± I <sub>IK</sub>	DC input diode current	$V_1 < -0.5 \text{ or } V_1 > V_{CC} + 0.5V$	20	mA
± I <sub>OK</sub>	DC output diode current	$V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5V$	50	mA
±I <sub>O</sub>	DC output source or sink current  – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
± I <sub>GND</sub> , ± I <sub>CC</sub>	DC V <sub>CC</sub> or GND current for types with – standard outputs		50	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package  – plastic DIL  – plastic mini-pack (SO)  – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

## NOTES:

# DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	+125°C	UNIT
		1201 001121110110	MIN	TYP. NO TAG	MAX	MIN	MAX	
		V <sub>CC</sub> = 1.2V	0.9			0.9		
$V_{IH}$	HIGH level Input	V <sub>CC</sub> = 2.0V	1.4			1.4		V
VIН	voltage	V <sub>CC</sub> = 2.7 to 3.6V	2.0			2.0		1 °
		V <sub>CC</sub> = 4.5 to 5.5V	0.7 * V <sub>CC</sub>			0.7 * V <sub>CC</sub>		1
		V <sub>CC</sub> = 1.2V			0.3		0.3	
VIL	LOW level Input	V <sub>CC</sub> = 2.0V			0.6		0.6	<sub>v</sub>
V IL	voltage	V <sub>CC</sub> = 2.7 to 3.6V			0.8		0.8	ľ
		$V_{CC} = 4.5 \text{ to } 5.5$			0.3 * V <sub>CC</sub>		0.3 * V <sub>CC</sub>	
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu A$		1.2				
	LUCI Haval avitavit	$V_{CC} = 2.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	1.8	2.0		1.8		]
$V_{OH}$	HIGH level output voltage; all outputs	$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	2.5	2.7		2.5		V
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu A$	2.8	3.0		2.8		]
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	4.3	4.5		4.3		
V <sub>OH</sub>	HIGH level output voltage;	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 6\text{mA}$	2.40	2.82		2.20		V
VOH	STANDARD outputs	$V_{CC} = 4.5V$ ; $V_{I} = V_{IH}$ or $V_{IL}$ ; $-I_{O} = 12mA$	3.60	4.20		3.50		ľ
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0				
	L OW law at autout	$V_{CC} = 2.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	]
$V_{OL}$	LOW level output voltage; all outputs	$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	V
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2	
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	
V <sub>OL</sub>	LOW level output voltage;	$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 6mA$		0.25	0.40		0.50	V
V OL	STANDARD outputs	$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 12mA$		0.35	0.55		0.65	

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>2.</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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# DC ELECTRICAL CHARACTERISTICS (Continued)

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

			LIMITS								
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +85	5°C	-40°C to	UNIT				
			MIN	TYP. NO TAG	MAX	MIN	MAX				
I <sub>I</sub>	Input leakage current	$V_{CC} = 5.5V$ ; $V_I = V_{CC}$ or GND			1.0		1.0	μА			
Icc	Quiescent supply current; SSI	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		40	μА			
Δl <sub>CC</sub>	Additional quiescent supply current	$V_{CC} = 2.7V$ to 3.6V; $V_I = V_{CC} - 0.6V$			500		850	μА			

## NOTE:

## **AC CHARACTERISTICS**

GND = 0V;  $t_r = t_f \le 2.5$ ns;  $C_L = 50$ pF;  $R_L = 1$ K $\Omega$ 

			CONDITION		LIMITS						
SYMBOL	PARAMETER	WAVEFORM	CONDITION	-	-40 to +85°	С	-40 to	UNIT			
			V <sub>CC</sub> (V)	MIN	TYP NO TAG	MAX	MIN	MAX			
			1.2		40						
	Barren deler		2.0		14	20		25			
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay	Propagation delay nA to nY Figure 1 2.7 3.0 to 3.6	2.7		10	15		19	ns		
	1,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		3.0 to 3.6		8NO TAG	12		15			
1			4.5 to 5.5			9		11			

#### NOTES:

- 1. Unless otherwise stated, all typical values are measured at  $T_{amb} = 25$ °C
- 2. Typical values are measured at  $V_{CC} = 3.3 \text{ V}$ .

# **AC WAVEFORMS**

$$\begin{split} &V_M = 1.5 \text{ V at } V_{CC} \geq 2.7 \text{ V and} \leq 3.6 \text{ V}; \\ &V_M = 0.5 \times V_{CC} \text{ at } V_{CC} < 2.7 \text{ V and} \geq 4.5 \text{ V}; \end{split}$$

 $\mbox{V}_{\mbox{OL}}$  and  $\mbox{V}_{\mbox{OH}}$  are the typical output voltage drop that occur with the output load.

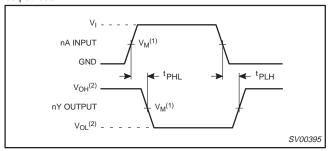


Figure 1. Input (nA) to output (nY) propagation delays and output transition times.

## **TEST CIRCUIT**

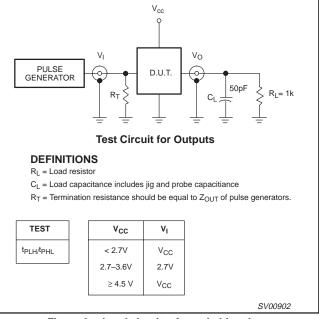


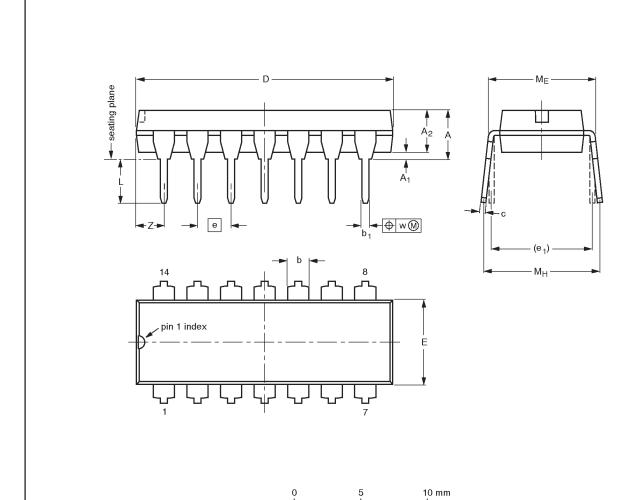
Figure 2. Load circuitry for switching times

<sup>1.</sup> All typical values are measured at  $T_{amb} = 25$ °C.

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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

#### Note

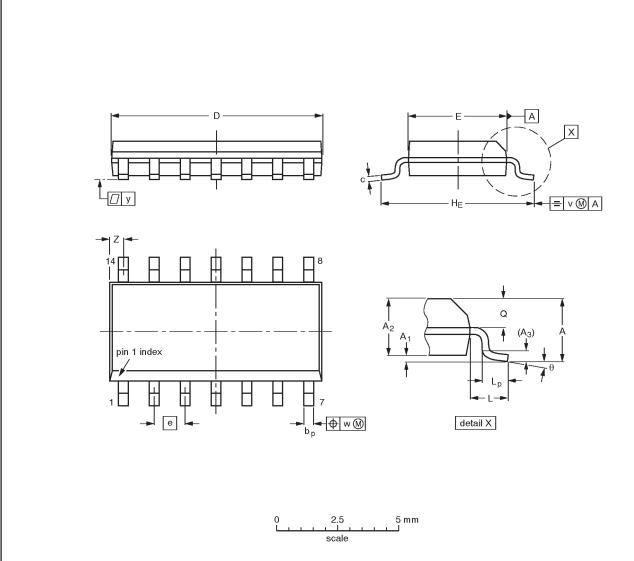
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	VERSION IEC JEDEC EIAJ		PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA			<del>92-11-17</del> 95-03-11

Hex inverter 74LV04

# SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



# DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	Α1	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bр	c	D <sup>(1)</sup>	E <sup>(1)</sup>	Φ	HE	L	Lρ	Ø	>	v	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	1.0.060	0.0098 0.0039		0.01		0.0098 0.0075	0.35 0.34	0.16 0.15	0.050	0.24 0.23	0.041		0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

#### Note

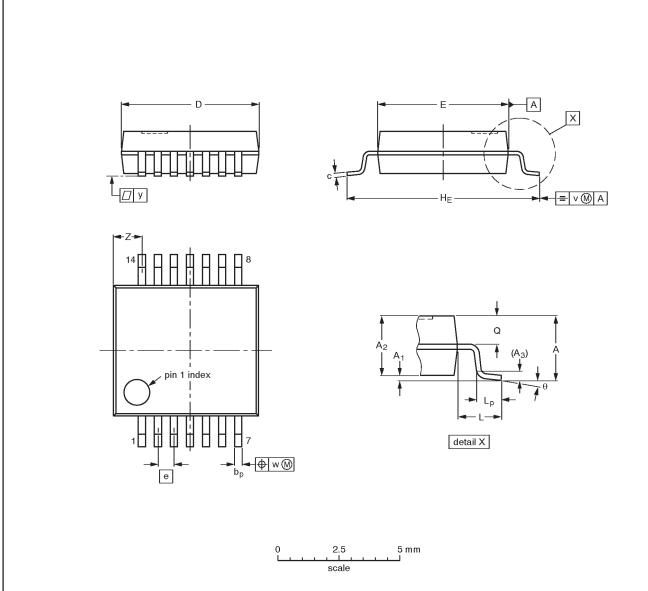
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT108-1	076E06\$	MS-012AB				<del>91-08-13</del> 95-01-23	

Hex inverter 74LV04

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



## DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	рb	O	D <sup>(1)</sup>	E <sup>(1)</sup>	Ф	HE	L	Lp	ø	٧	w	у	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

#### Note

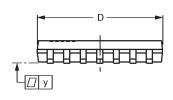
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

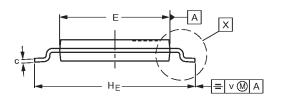
OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT337-1		MO-150AB				<del>-95-02-04</del> 96-01-18

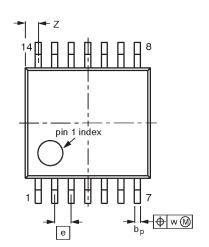
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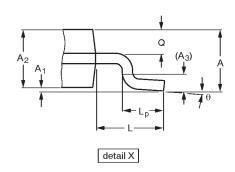
TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1











## DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bр	C	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Ø	v	w	у	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1550E DATE	
SOT402-1		MO-153				<del>94-07-12</del> 95-04-04	

Hex inverter 74LV04

	DEFINITIONS							
Data Sheet Identification	Product Status	Definition						
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.						
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.						
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